

MAXIM

MAX3880 Evaluation Kit

General Description

The MAX3880 evaluation kit (EV kit) simplifies evaluation of the MAX3880 2.488Gbps, SDH/SONET 1:16 deserializer with clock recovery. The EV kit requires only a single +3.3V supply and includes all the external components necessary to interface with 3.3V CML inputs and LVDS output logic. The board can be connected to the output of a limiting amplifier circuit (such as the MAX3866) and to the input of an LVDS device (such as an overhead termination circuit). A signal generator or stimulus system can be used with an oscilloscope to evaluate the MAX3880's basic functionality.

Features

- ◆ Single +3.3V Supply
- ◆ Test Point for Monitoring Loss-of-Lock (LOL)
- ◆ Fully Assembled and Tested Surface-Mount Board

Ordering Information

PART	TEMP. RANGE	IC PACKAGE
MAX3880EVKIT	-40°C to +85°C	64 TQFP-EP

Component List

DESIGNATION	QTY	DESCRIPTION
C1, C2, C3, C6, C8, C15, C16, C17	8	0.1μF, 25V min, 10% ceramic capacitors (0603)
C4, C5, C7, C12, C13, C14, C19, C20, C21	9	100pF, 25V min, 10% ceramic capacitors (0603)
C9	1	33μF ±10%, 10V min tantalum caps Sprague 293D336X0010C2
C10	1	2.2μF ±10%, 10V min tantalum caps Sprague 293D225X0010A2
C11	1	Not installed
C22	1	1μF, 25V min, 10% ceramic capacitor (0805)
D1	1	PC mount LED
J1–J4	4	SMA connectors (PC mount)
J5–J40	36	SMB connectors (PC mount)
L1, L2, L3	3	56nH inductors Coilcraft 0805CS-560XKBC
R1	1	2kΩ variable resistor
R2, R3	2	1kΩ, 1% resistors (0603)
R4	1	392Ω, 1% resistor (0603)
R5, R6, R11, R13, R14, R16, R17, R19, R20, R22, R23, R25, R26, R28, R29, R31, R32, R34, R35, R37, R38, R40, R41, R43, R44, R46, R47, R49, R50, R51, R52, R54, R55, R57, R58	35	Not installed

DESIGNATION	QTY	DESCRIPTION
R7, R12, R15, R18, R21, R24, R27, R30, R33, R36, R39, R42, R45, R48, R53, R56, R59	17	100Ω, 1% resistors
U1	1	MAX3880ECB (64-pin TQFP-EP)
GND, +3.3V	2	Test points
JH1, JH2	2	Not installed
JU1–JU5	5	Not installed
JU6, JU7	2	Shunts
JU6	1	3-pin header (0.1" centers)
JU7	1	2-pin headers (0.1" centers)
None	1	MAX3880 evaluation kit circuit board (Rev. B)
None	1	MAX3880 data sheet

Component Suppliers

SUPPLIER	PHONE	FAX
Coilcraft	847-639-6400	847-639-1469
Sprague	603-224-1961	603-224-1430

Note: Please indicate that you are using the MAX3880 when contacting these component suppliers.

Evaluates: MAX3880



MAX3880 Evaluation Kit

Detailed Description

The MAX3880 EV kit simplifies evaluation of the MAX3880 1:16 deserializer with clock recovery. The EV kit operates from a single +3.3V supply and includes all the external components necessary to interface with 3.3V CML inputs and LVDS outputs.

Connections

Input terminals for the differential 2.488Gbps serial-data input (SDI+, SDI-, SLBI+, SLBI-) are AC-coupled to on-board SMA connectors. Limiting amplifiers with differential output swings between 50mVp-p and 800mVp-p can be connected directly to the SMA connectors. All LVDS outputs (PCLK+, PCLK-, PD+, PD-) are differentially terminated with 100 Ω resistors between complementary outputs. Each output can directly drive a high-impedance input oscilloscope (see Connecting to 50 Ω Oscilloscope Inputs in the *Applications Information* section). When driving an LVDS input that already includes 100 Ω differential termination, remove the termination resistor corresponding to the appropriate LVDS output.

The synchronization input (SYNC+, SYNC-) is an LVDS input internally terminated with 100 Ω differential input resistance. Ensure that LVDS devices driving this input are not redundantly terminated. All signal inputs and outputs use coupled 50 Ω transmission lines. All output signal lines are of equal length to minimize propagation-delay skew.

Setup

- 1) Select either the serial-data inputs, pins 2 and 3 of JU6 (SDI EN), or the system loopback inputs, pins 1 and 2 of JU6 (SLBI EN) with a 2-pin jumper.
- 2) Verify that the shunt across jumper JU7 is in place.
- 3) Connect the +3.3V power supply to the appropriate terminals marked on the EV kit and apply power.
- 4) Connect a 2.5Gbps NRZ data signal (<800mVp-p differential) to the selected inputs with 50 Ω cables.
- 5) Connect the LVDS outputs to a high-impedance oscilloscope or refer to the *Applications Information* section.

Phase Adjustment

Internal phase adjustment is available on the MAX3880 EV kit. Phase adjust (PHADJ) R1, although not required, can be used to shift the sampling edge of the recovered clock relative to the center of the data eye. Ensure JU7 is removed when adjusting PHADJ.

Loss-of-Lock Monitor

Phase-locked loop (PLL) frequency lock conditions can be monitored at the high-impedance loss-of-lock (LOL) test point. A TTL high (LED off) indicates PLL frequency lock, while a TTL low (LED on) indicates a loss-of-lock condition. Note that the LOL circuitry will not detect a loss-of-power condition (refer to the MAX3880 data sheet).

Layout Considerations

The MAX3880's performance can be greatly affected by circuit-board layout and design. Use good high-frequency design techniques, including minimizing ground inductances and using fixed-impedance transmission lines on the data and clock signals.

Table 1. Jumpers and Test Points

NAME	TYPE	DESCRIPTION	NORMAL POSITION
JU6	3-pin	Selects between the serial-data input and the system loopback function of the MAX3880.	Shorted between 2, 3
JU7	2-pin	Disables PHADJ (R1)	Shorted (disabled)
$\overline{\text{LOL}}$	Test Point	Monitors $\overline{\text{LOL}}$ voltage level	—

Applications Information

Connecting LVDS Outputs to 50 Ω Oscilloscope Inputs

To monitor an LVDS signal on a 50 Ω input oscilloscope, remove the differential load resistor between the complementary outputs and AC couple each output to an oscilloscope input. For example, to observe the PD0 signal on a 50 Ω input instrument, remove resistor R15 from the EV board and place a capacitor or DC block in series with each output (PD0+ or PD0-) and the instrument input. **Do not connect MAX3880 outputs directly to 50 Ω inputs or terminations to ground.** Choose a coupling capacitor large enough in value to prevent pattern-dependent distortion of the output signal.

Exposed Pad (EP) Package

The exposed pad 64-pin TQFP incorporates features that provide a very low thermal resistance path for heat removal from the integrated circuit—either to a printed circuit board or to an external heatsink. The MAX3880's exposed pad must be soldered directly to a ground plane with good thermal conductance.

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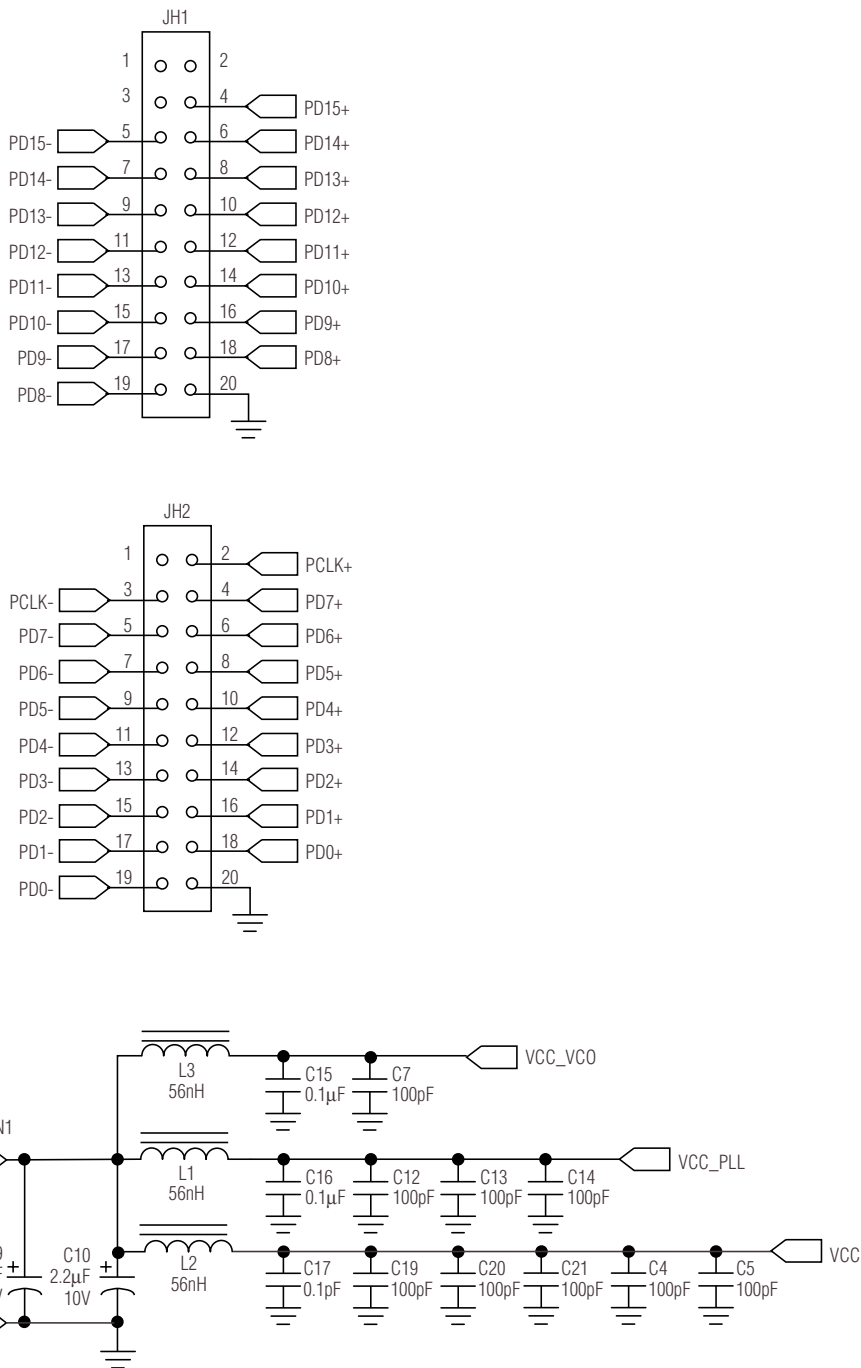


Figure 1. MAX3880 EV Kit Schematic

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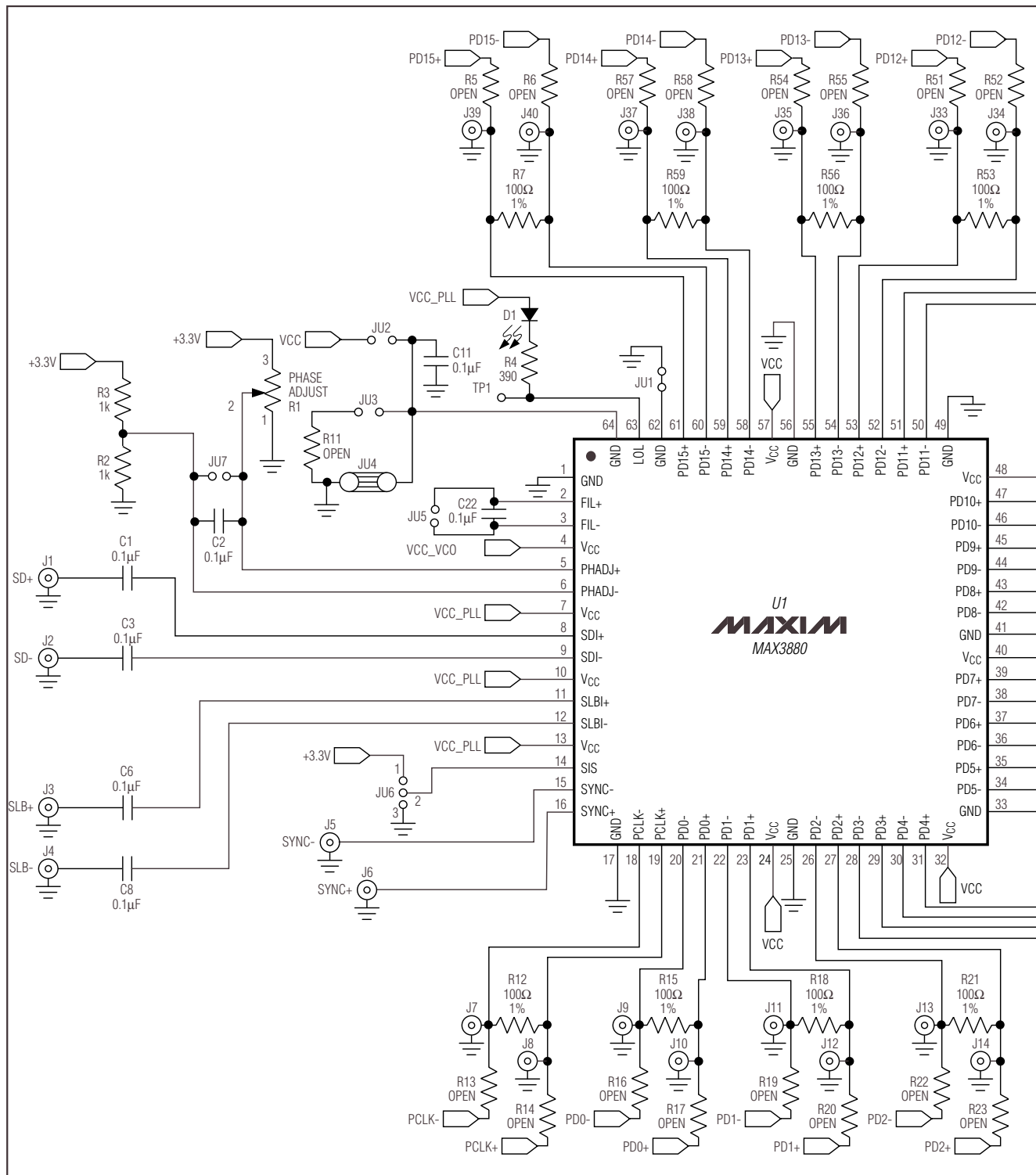


Figure 1. MAX3880 EV Kit Schematic (continued)

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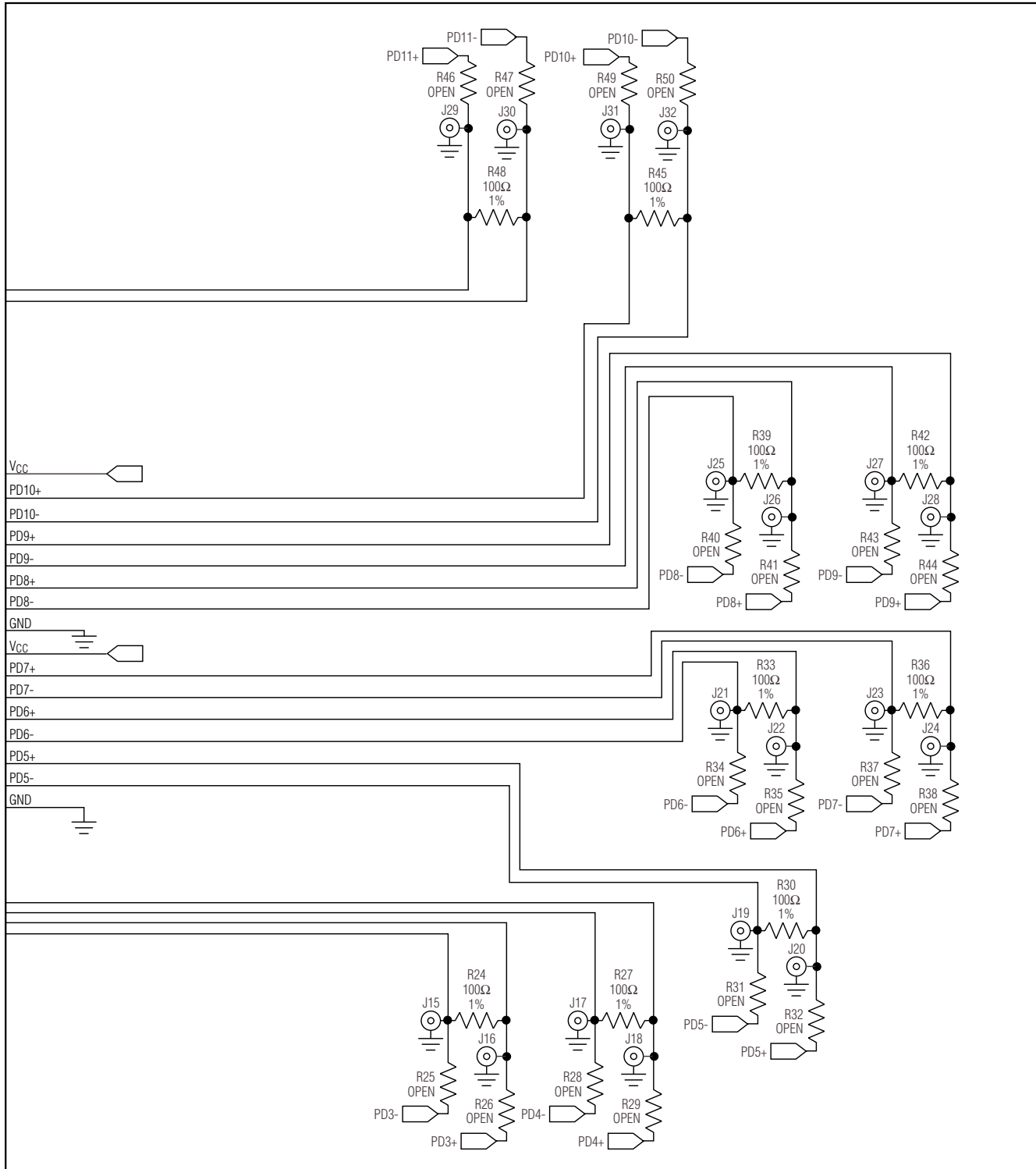


Figure 1. MAX3880 EV Kit Schematic (continued)

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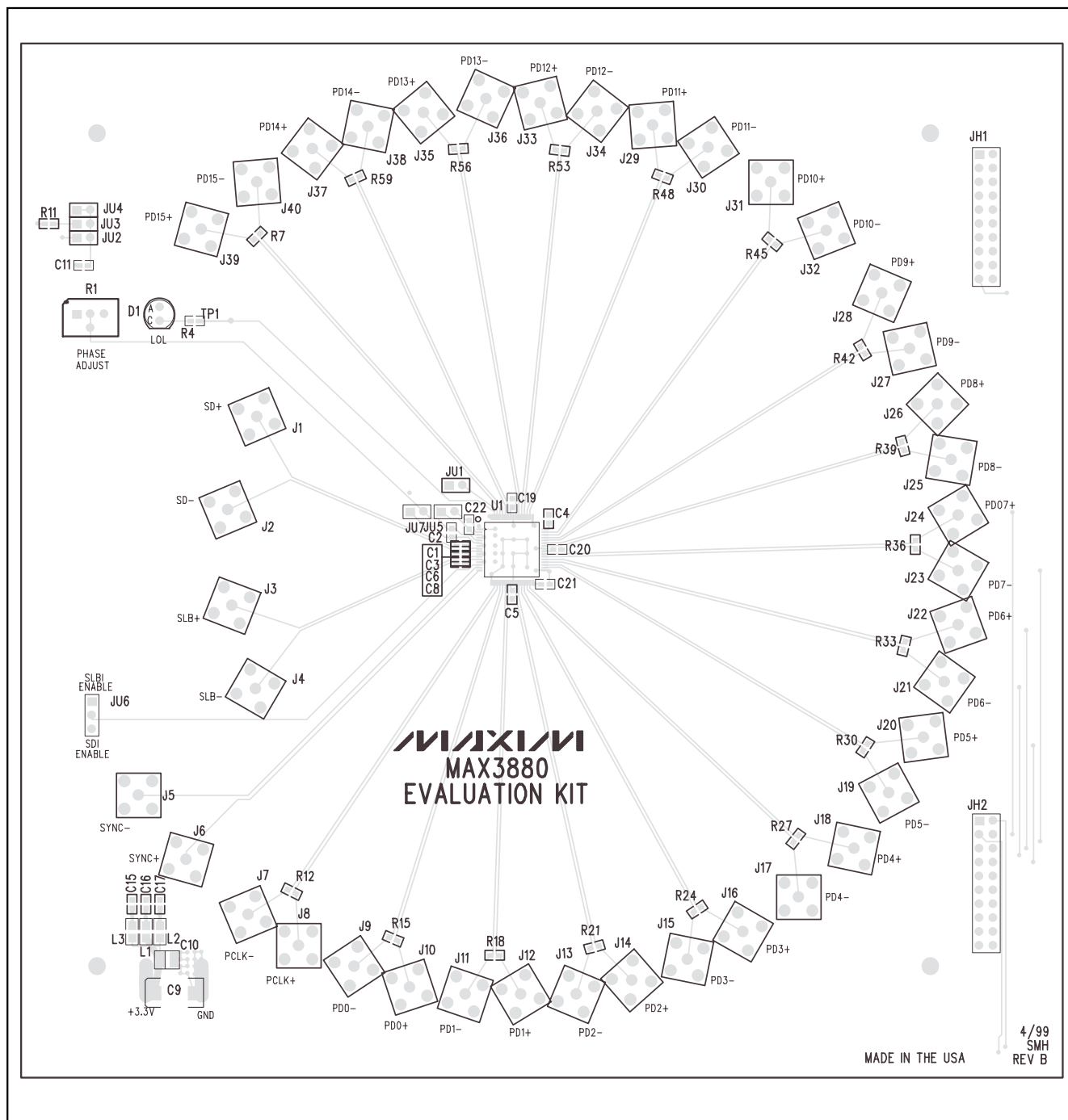


Figure 2. MAX3880 EV Kit Component Placement Guide—Component Side

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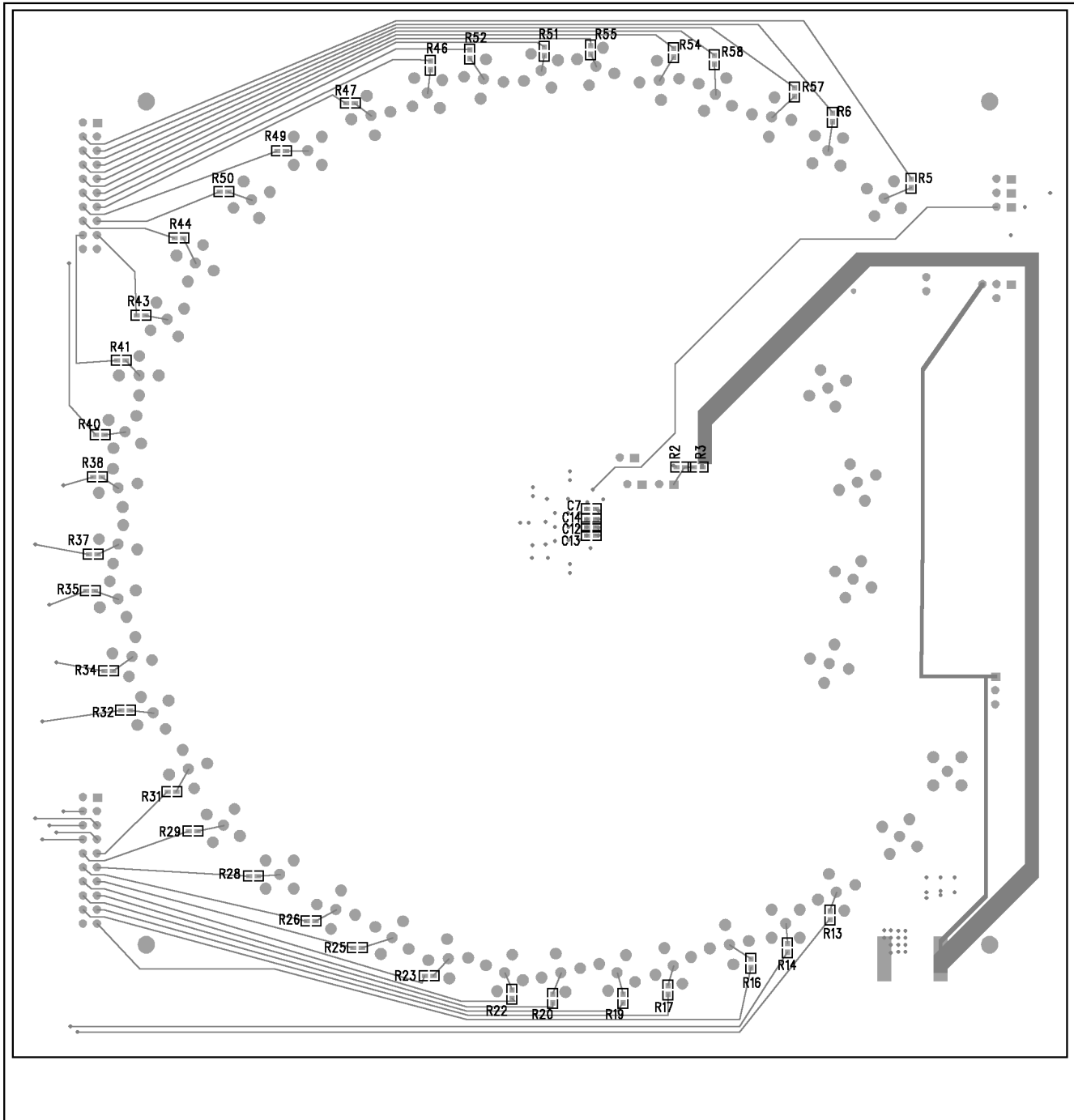


Figure 3. MAX3880 EV Kit Component Placement Guide—Solder Side

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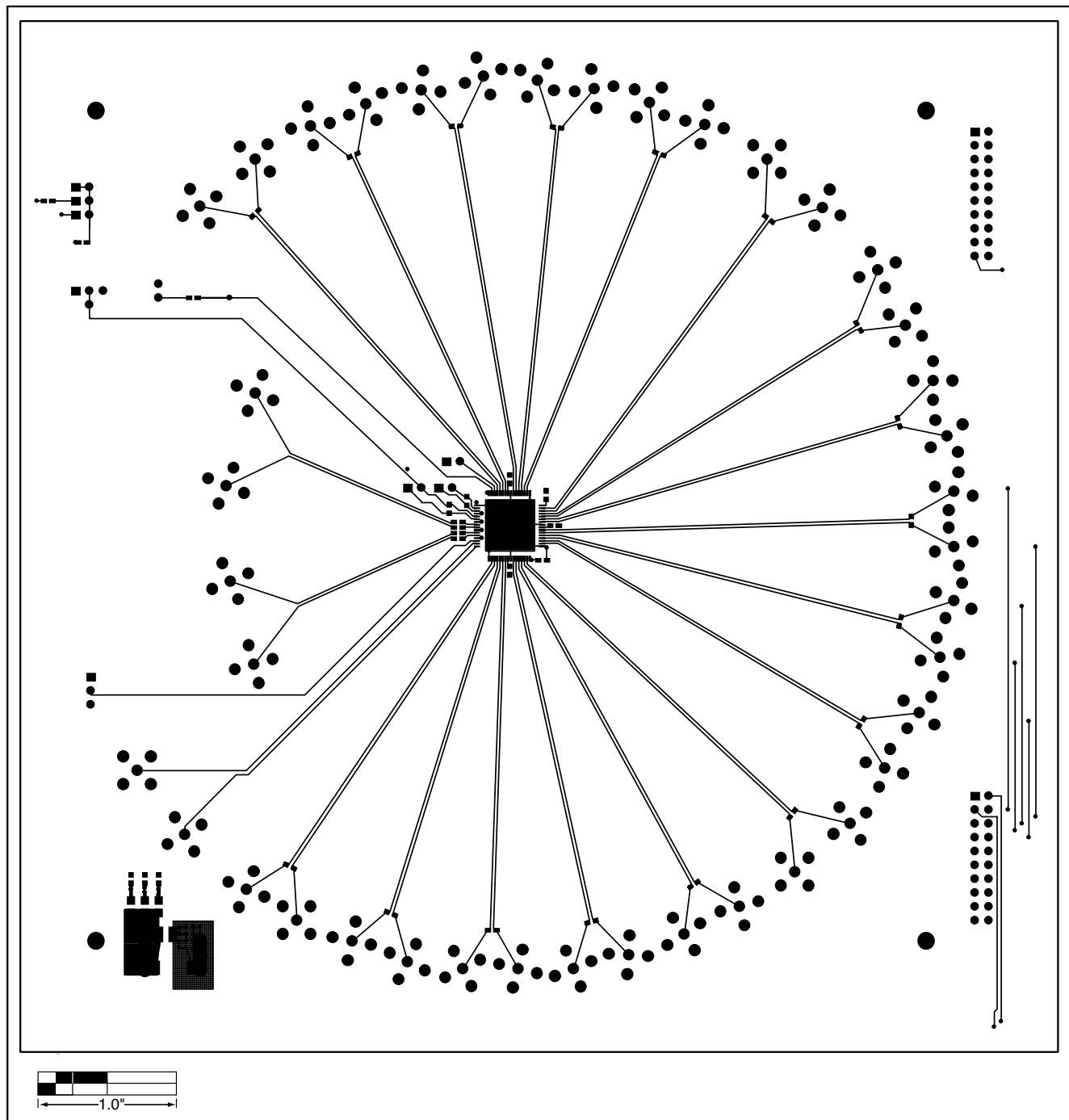


Figure 4. MAX3880 EV Kit PC Board Layout—Component Side

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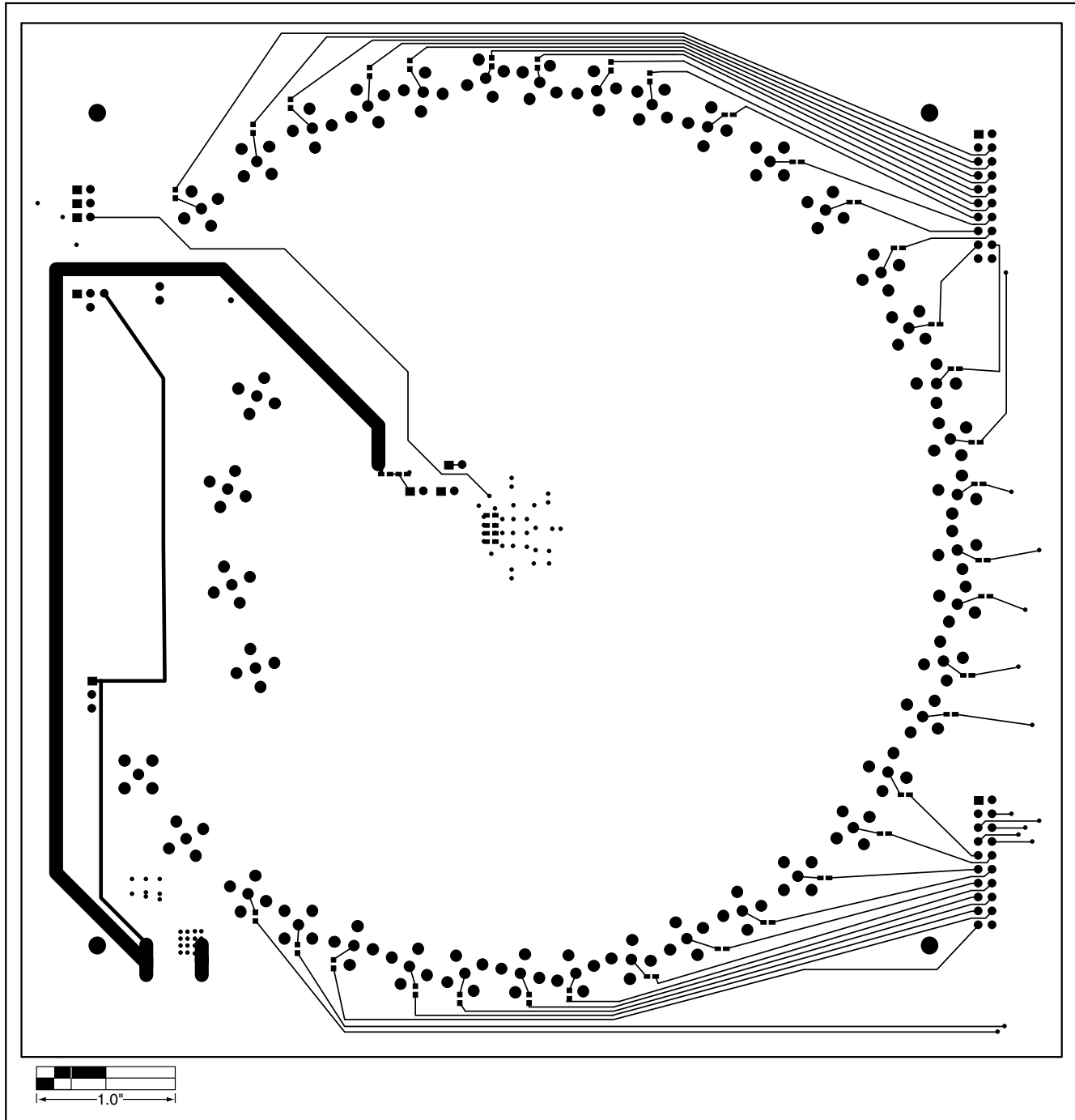


Figure 5. MAX3880 EV Kit PC Board Layout—Solder Side

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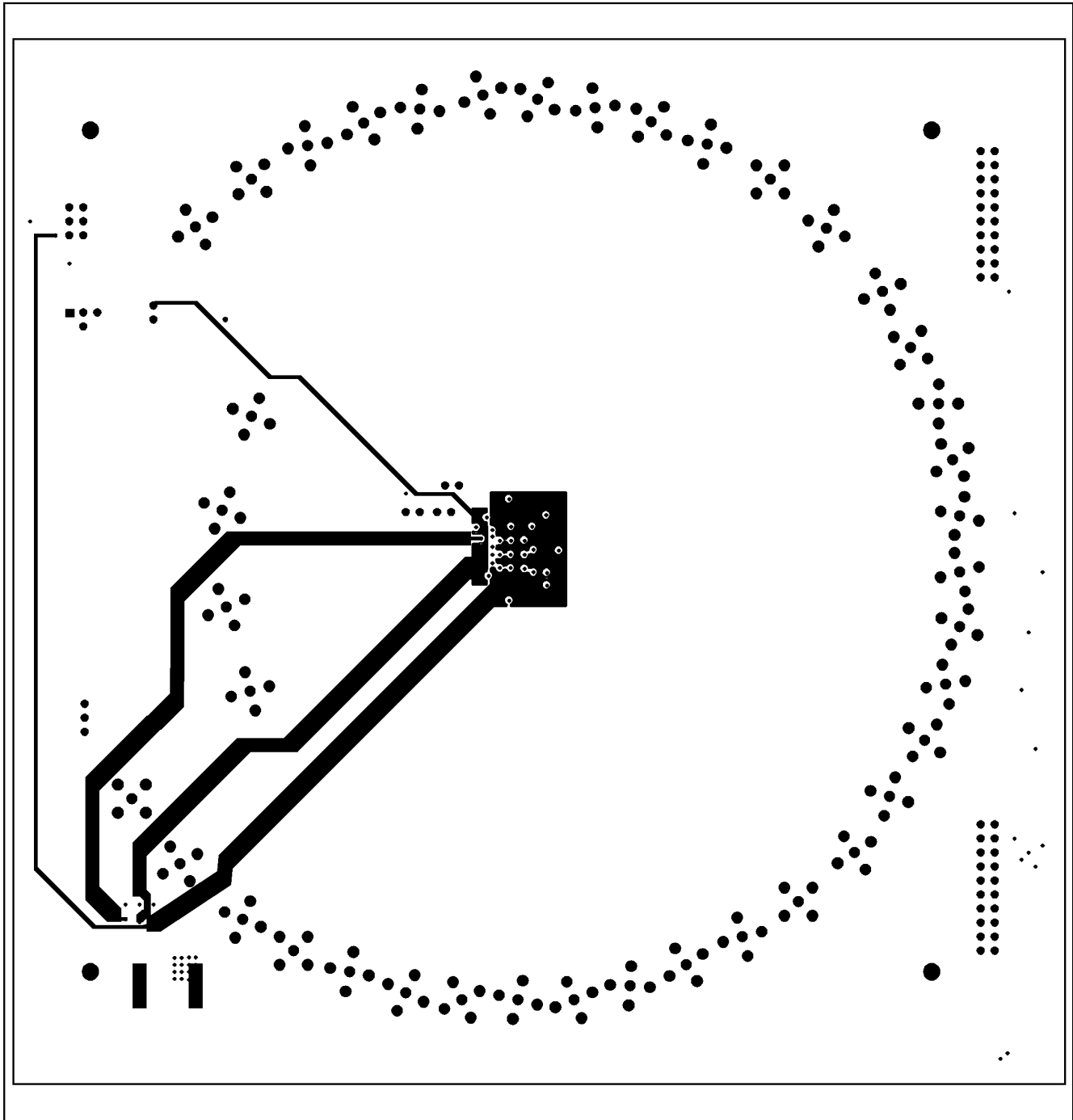


Figure 6. MAX3880 EV Kit PC Board Layout—Power Plane

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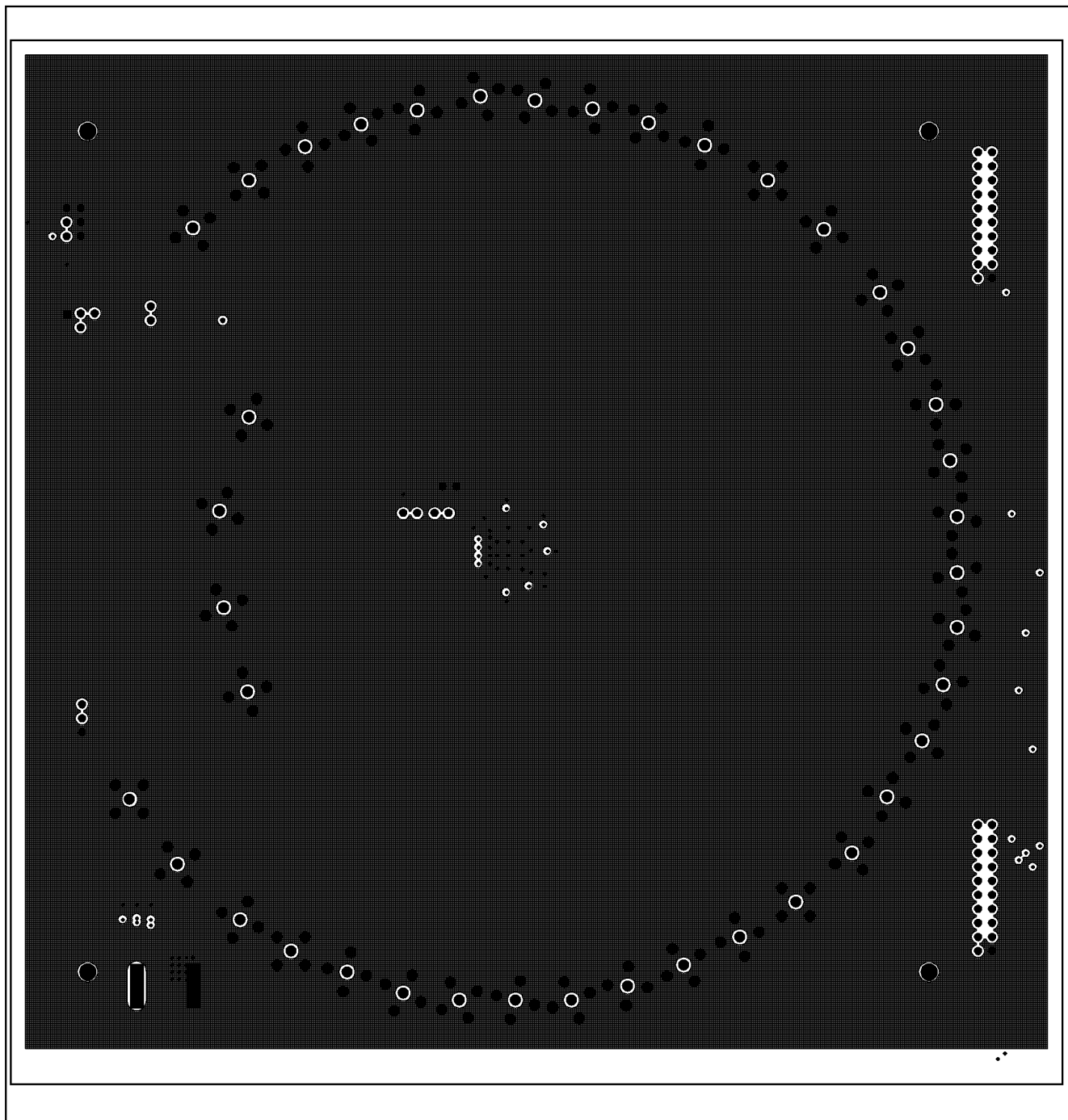


Figure 7. MAX3880 EV Kit PC Board Layout—Ground Plane

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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